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## OPUS Link Lab



Innovation thrives in experimentation—and that’s exactly what OPUS Link Lab was built for. At **FutureLink Barcelona 2025**, TraceLink Vice President of Product Marketing Jonathan LeBlanc introduced this free, sandbox-style environment where customers and partners can safely test integrations, explore OPUS technologies, and build new solutions without affecting production systems.

Designed to mirror the validation environment, OPUS Link Lab enables users to simulate real-world supply chain scenarios, develop and test configurations, and collaborate on new ideas that could become future marketplace offerings. Whether testing MINT and POET, experimenting with link actions, or creating workflows to address visibility challenges, users can use OPUS Link Lab to accelerate innovation across their supply chains.

### **Key Takeaways:**

- Gain hands-on experience with TraceLink’s OPUS technologies in a safe, fully featured environment.
- Build and test integrations, workflows, and custom solutions before deploying them in production.
- Collaborate with partners and explore new marketplace opportunities for multienterprise innovation.

Watch the session to see how OPUS Link Lab empowers supply chain leaders to experiment, innovate, and bring new digital solutions to life.

[Video](/category/video) [Multienterprise Information Network Tower \(MINT\)](/category/multienterprise-information-network-tower-mint) [Supply Chain Digitalization](/category/supply-chain-digitalization) [Supply Chain](/category/supply-chain)  
Meet with TraceLink to learn more about supply chain digitalization.  
Fill out the form to schedule a meeting now.

**Thank you! We will contact you soon!**

#### Related Content



#### **FutureLink Barcelona 2025 Keynote: Agentic Orchestration of Your End-to-End Supply Chain**

See how TraceLink's OPUS platform is enabling agentic orchestration—where automation, reasoning, and collaboration redefine supply chain performance.

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